

Amendment to the Abstract:

Please replace the paragraph beginning at page 15, line 4, with the following rewritten paragraph:

- - ~~The invention relates to a~~ A polyethylene molding material ~~having~~ has a bimodal molecular weight distribution ~~which has~~ with an overall density of $\geq 0.948 \text{ g/cm}^3$ and a melt flow index $\text{MFI}_{190/5}$ of $\leq 0.2 \text{ dg/min}$. ~~It~~ The molding material comprises ~~an amount of~~ from 35 to 65% by weight of low-molecular-weight ethylene homopolymer A ~~which has~~ having a viscosity number VN_A in the range from 40 to 90 cm^3/g , a melt flow index $\text{MFI}_{190/2.16 A}$ in the range from 40 to 2000 dg/min and a density d_A of $\geq 0.965 \text{ g/cm}^3$; ~~and an amount of.~~ Also included is from 35 to 65% by weight of high-molecular-weight ethylene copolymer B ~~which has~~ having a viscosity number VN_B in the range from 500 to 2000 cm^3/g , a melt flow index $\text{MFI}_{190/5 B}$ in the range from 0.02 to 0.2 dg/min and a density d_B in the range from 0.922 to 0.944 g/cm^3 . ~~The fraction of the molding material according to the invention obtained during a preparative TREF analysis at a temperature of $78^\circ\text{C} \pm 3 \text{ K}$ using p-xylene has an average molecular weight of $\geq 200,000 \text{ g/mol}$.~~ - -

Please delete the paragraph beginning at page 15, line 22.